

FRACTURE BEHAVIOUR OF TUNGSTEN MATERIALS

DEPENDING ON MICROSTRUCTURE
AND SURFACE FABRICATION

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Thanks for contributions and discussions to:
C. Bichler, B. Dafferner, C. Grubich,
S. Heger, U. Jäntschi, M. Klimenkov,
W. Krauss, P. Norajitra, J. Reiser,
W. Schulmeyer, H. Zimmermann

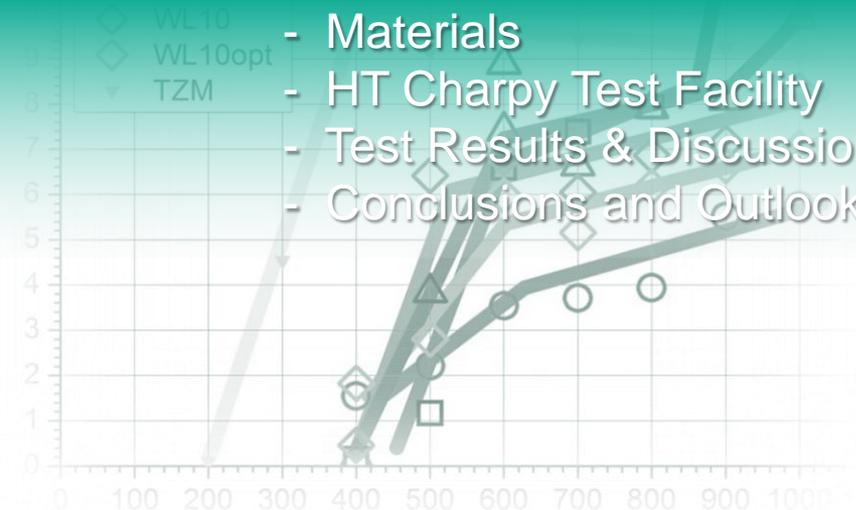


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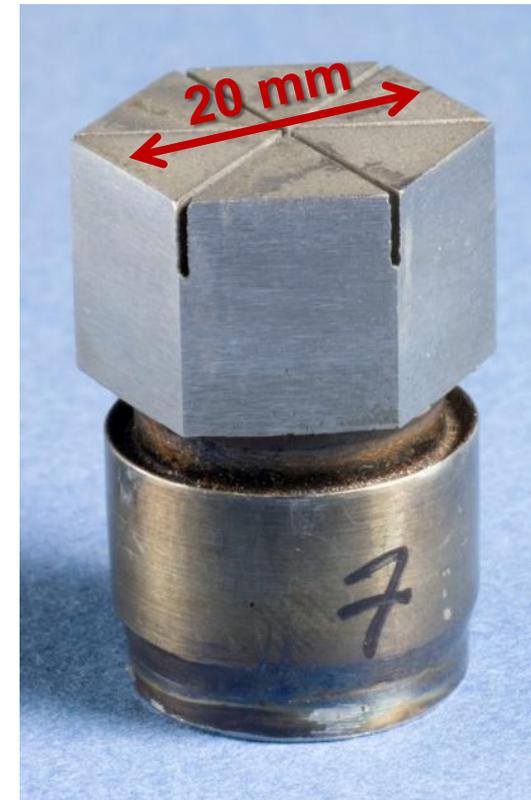
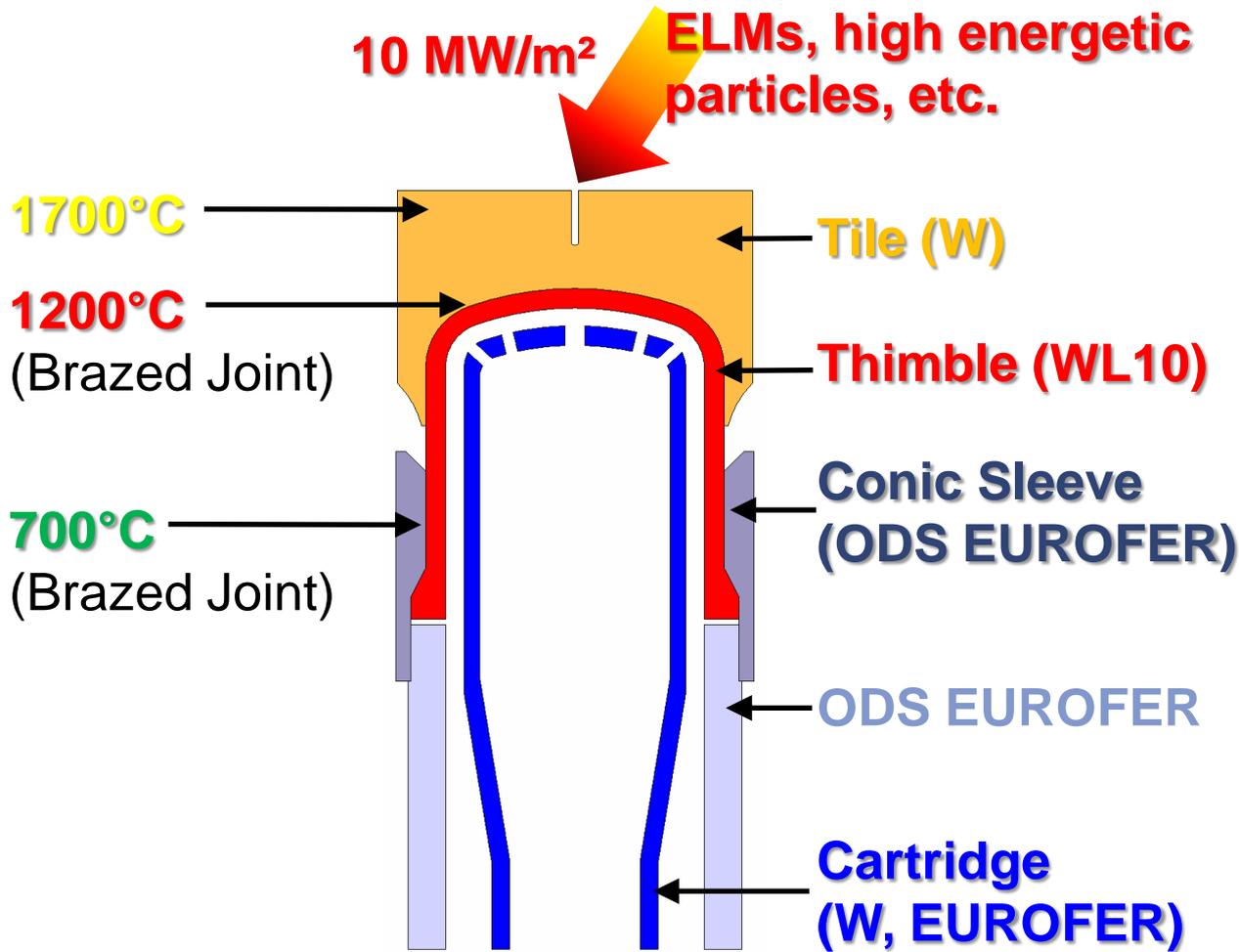


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- Contents**
- Overview
 - Materials
 - HT Charpy Test Facility
 - Test Results & Discussion
 - Conclusions and Outlook



Overview, DEMO Divertor Design



→ J. Reiser, P. Norajitra, this conference

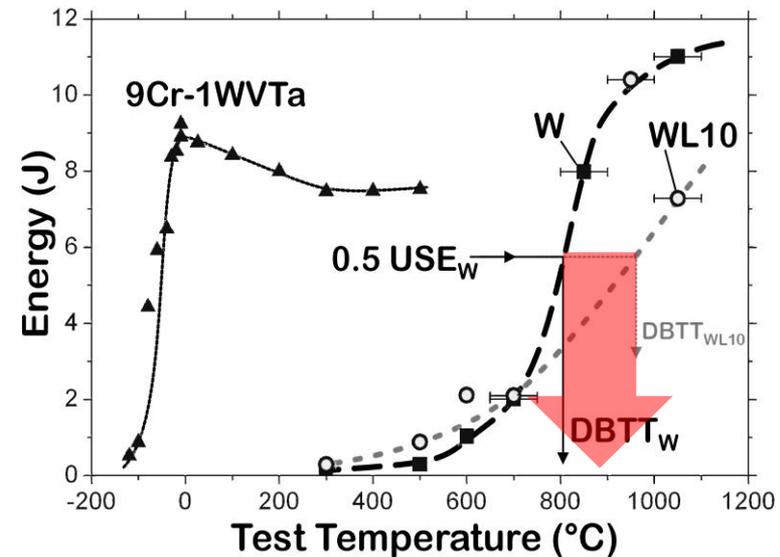
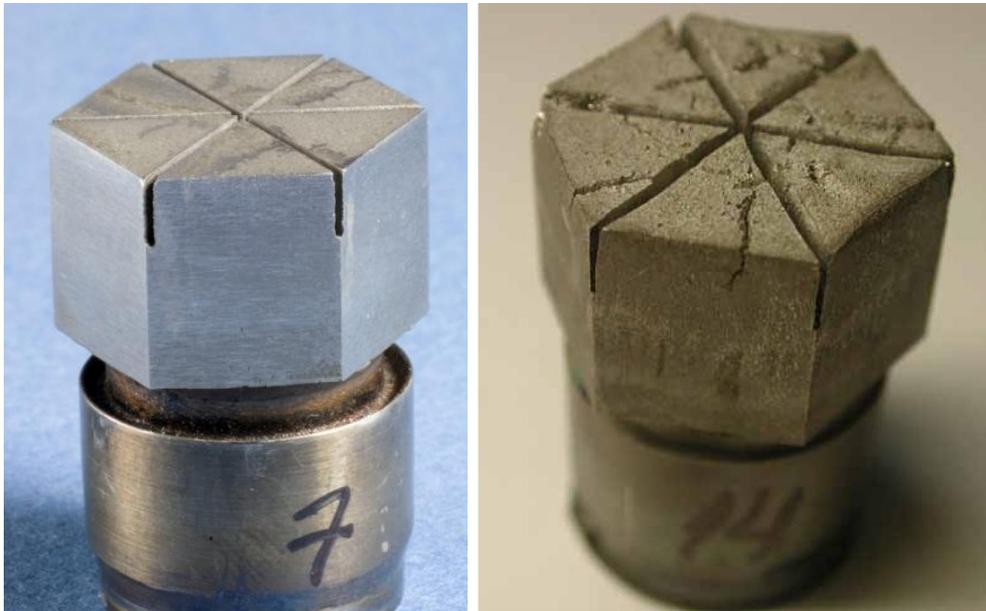
Motivation, Testing Method

Fracturing

- thermal load
- mechanical load ←
- manufacturing ←
- maintenance events

Charpy Test

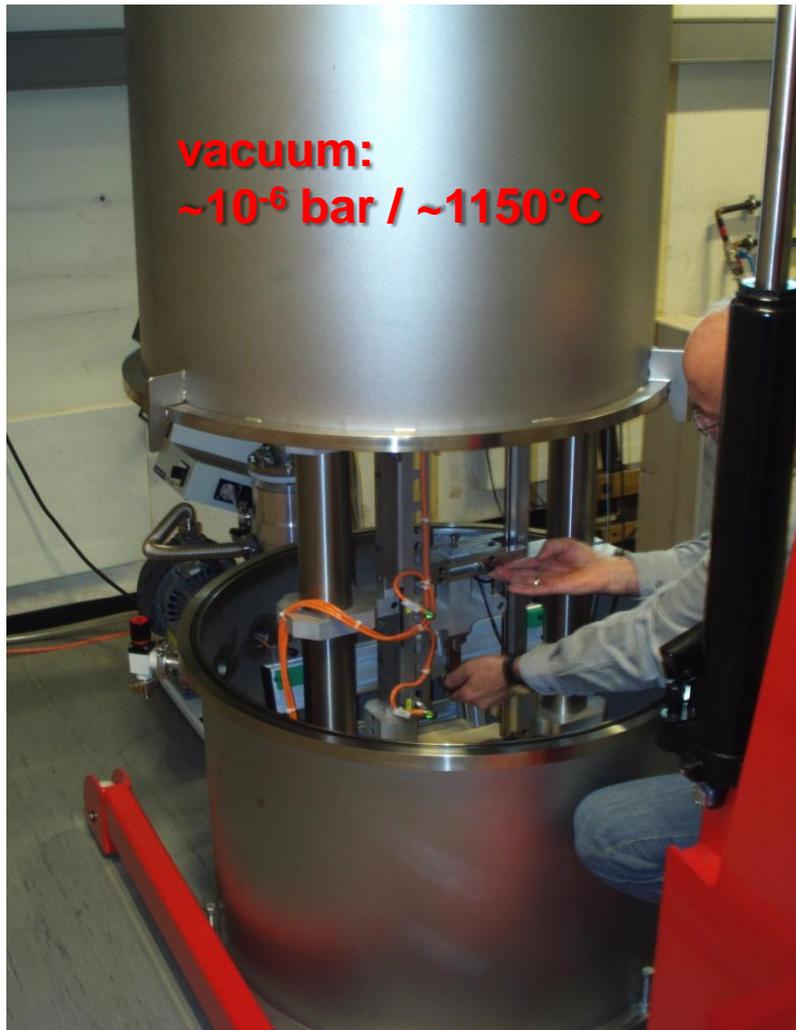
- DIN EU ISO 148-1, ...
- 3 mm x 4 mm x 27 mm
- notch depth 1 mm
- span 22 mm



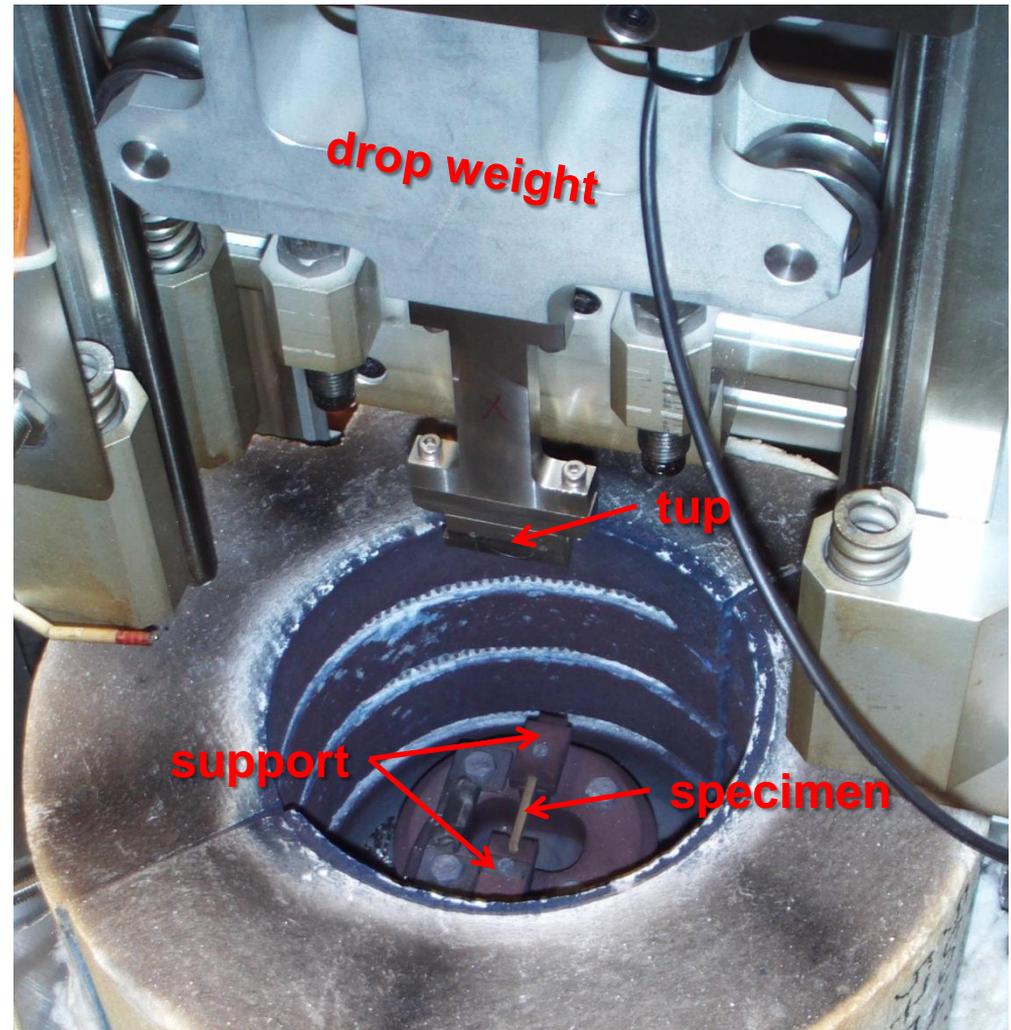
→ M. Rieth, B. Dafferner, JNM

→ P. Norajitra, W. Krauss, et al.

High Temperature Charpy Tests



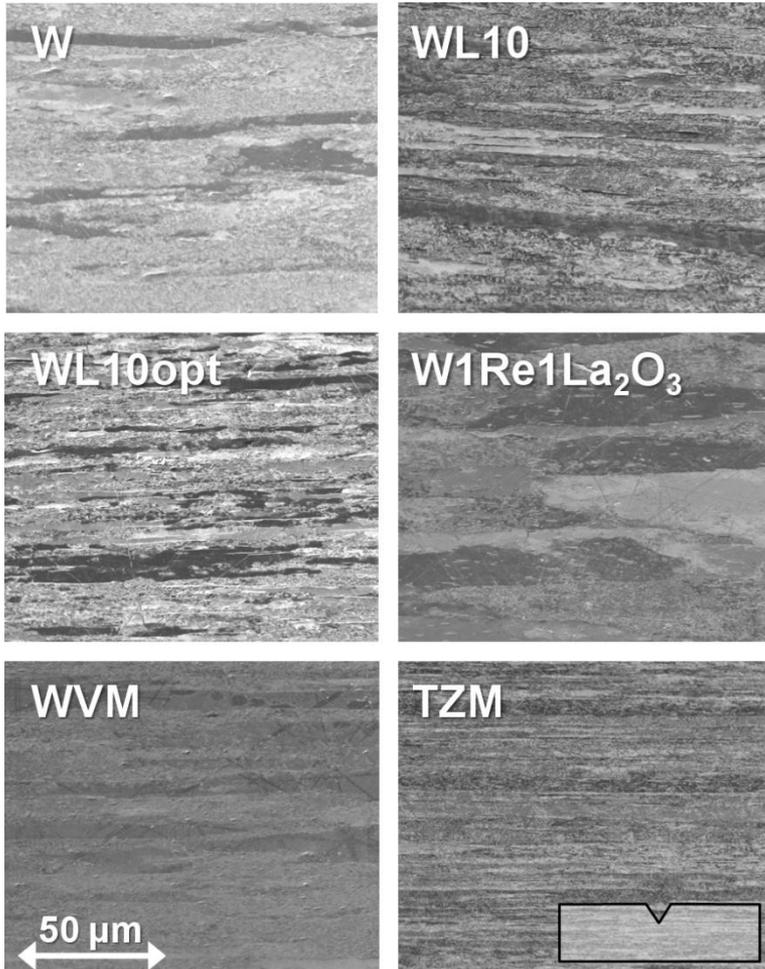
drop weight design, vacuum vessel



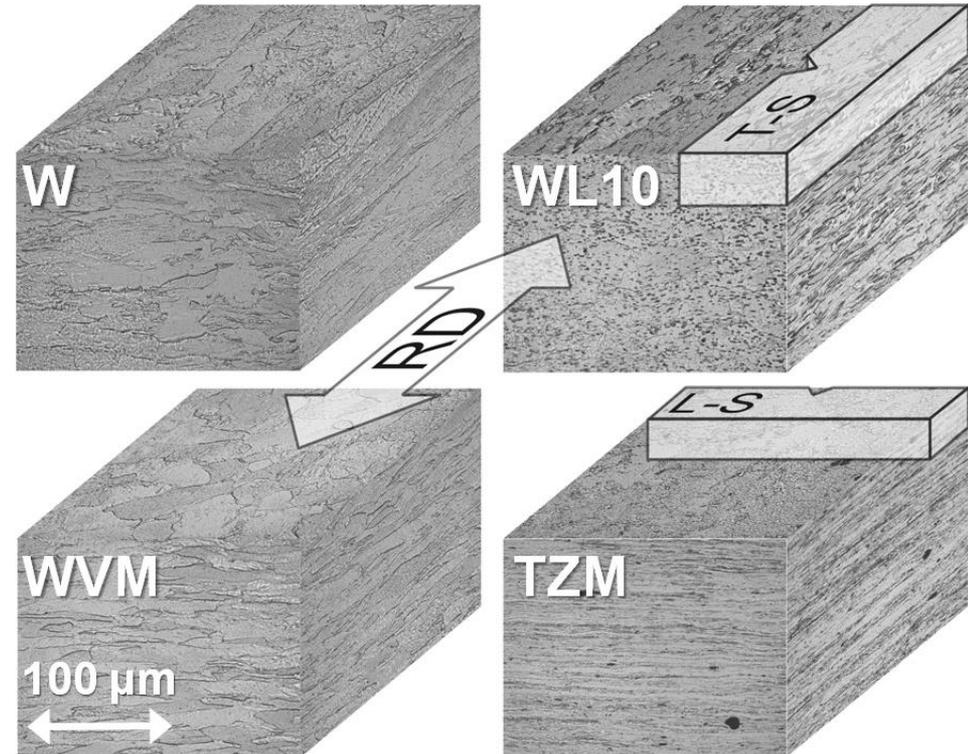
opened furnace: view on support

Materials, Rolling Texture

6 RODS



4 PLATES

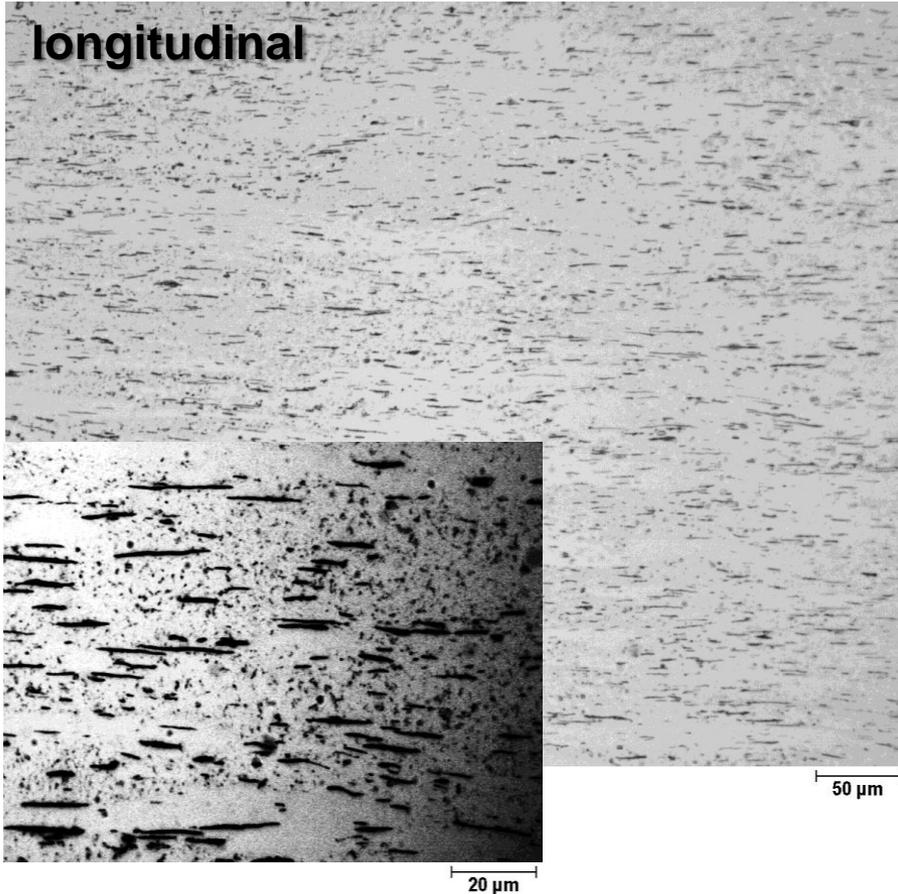


Microstructure

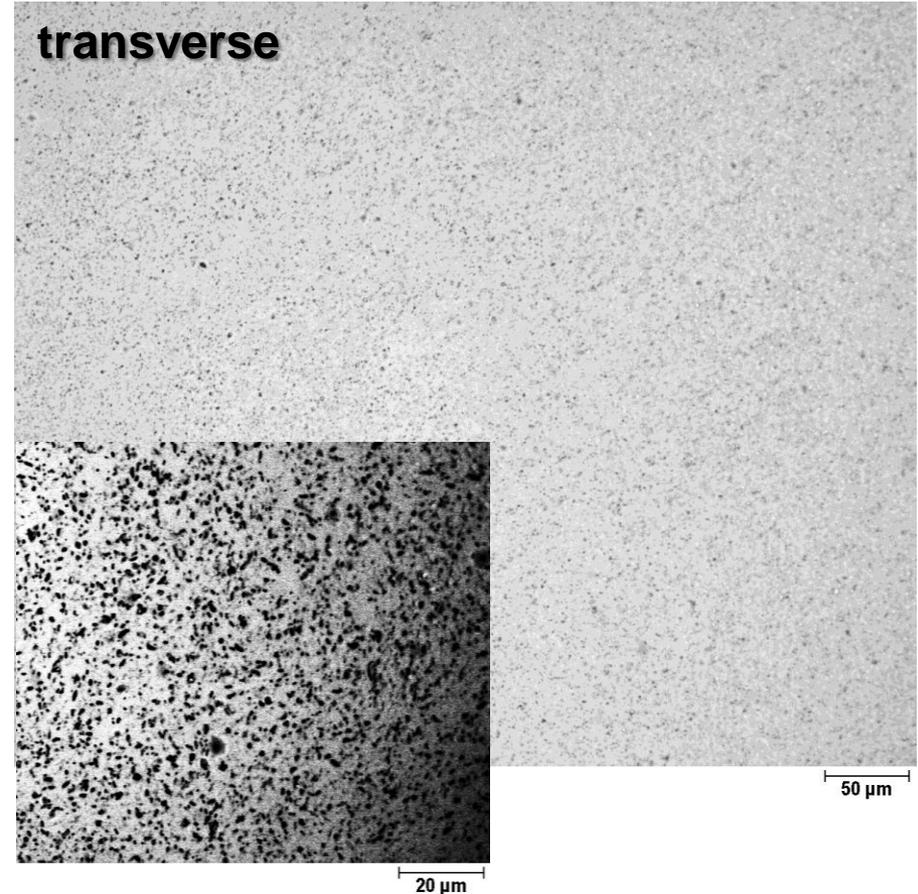
WL10 Rod, $\varnothing 7$ mm



longitudinal



transverse

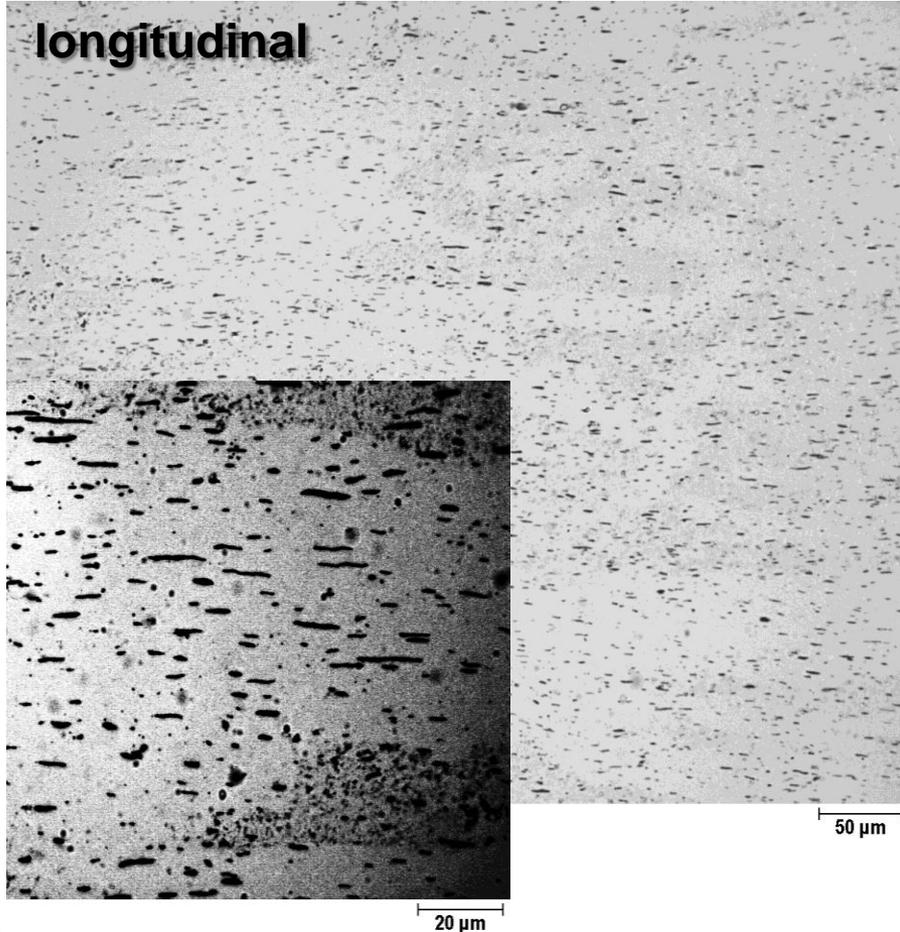


Microstructure

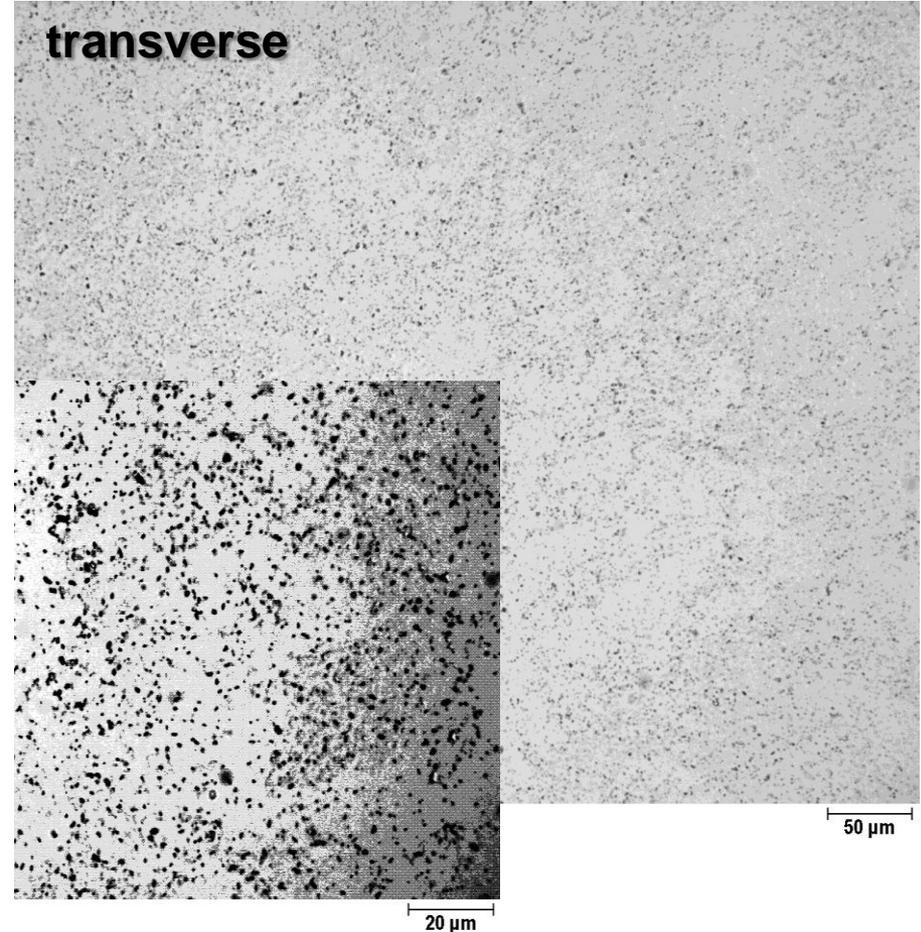
W-1%Re-1%La₂O₃ Rod, Ø10 mm



longitudinal

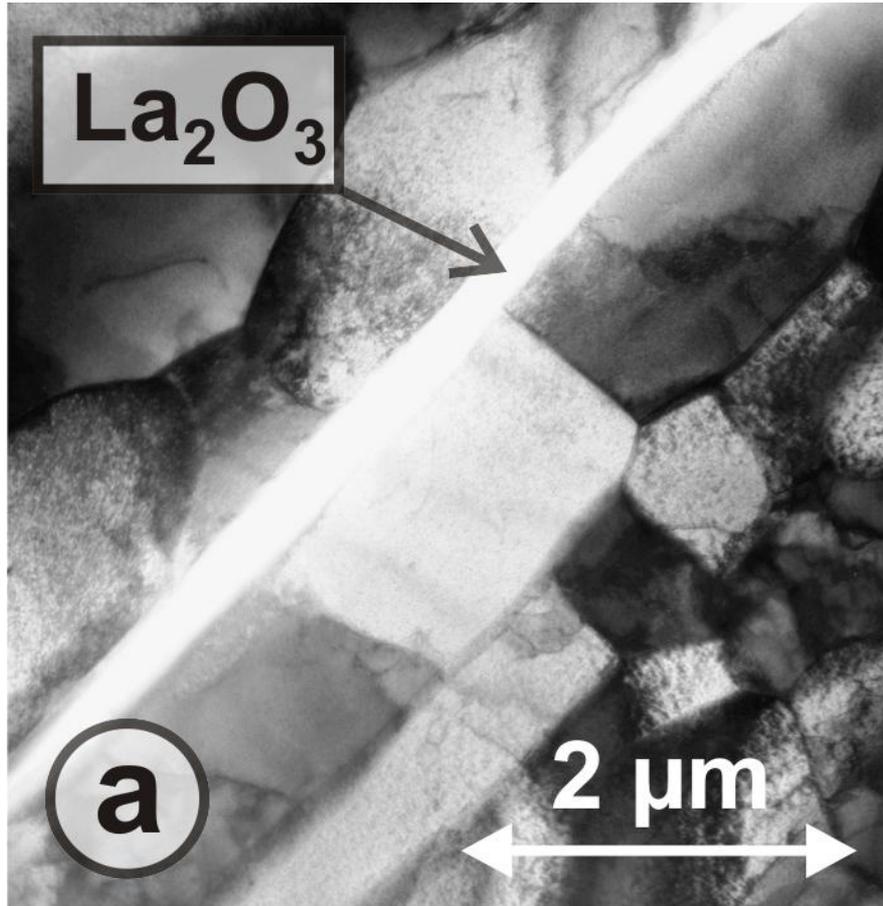


transverse

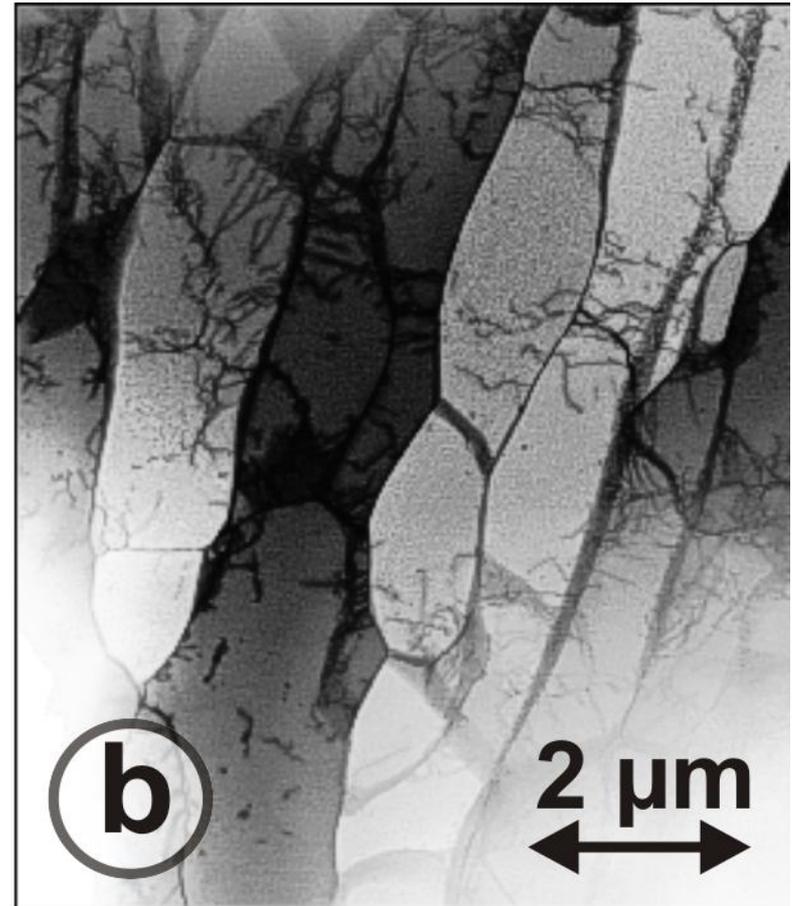


TEM Analysis

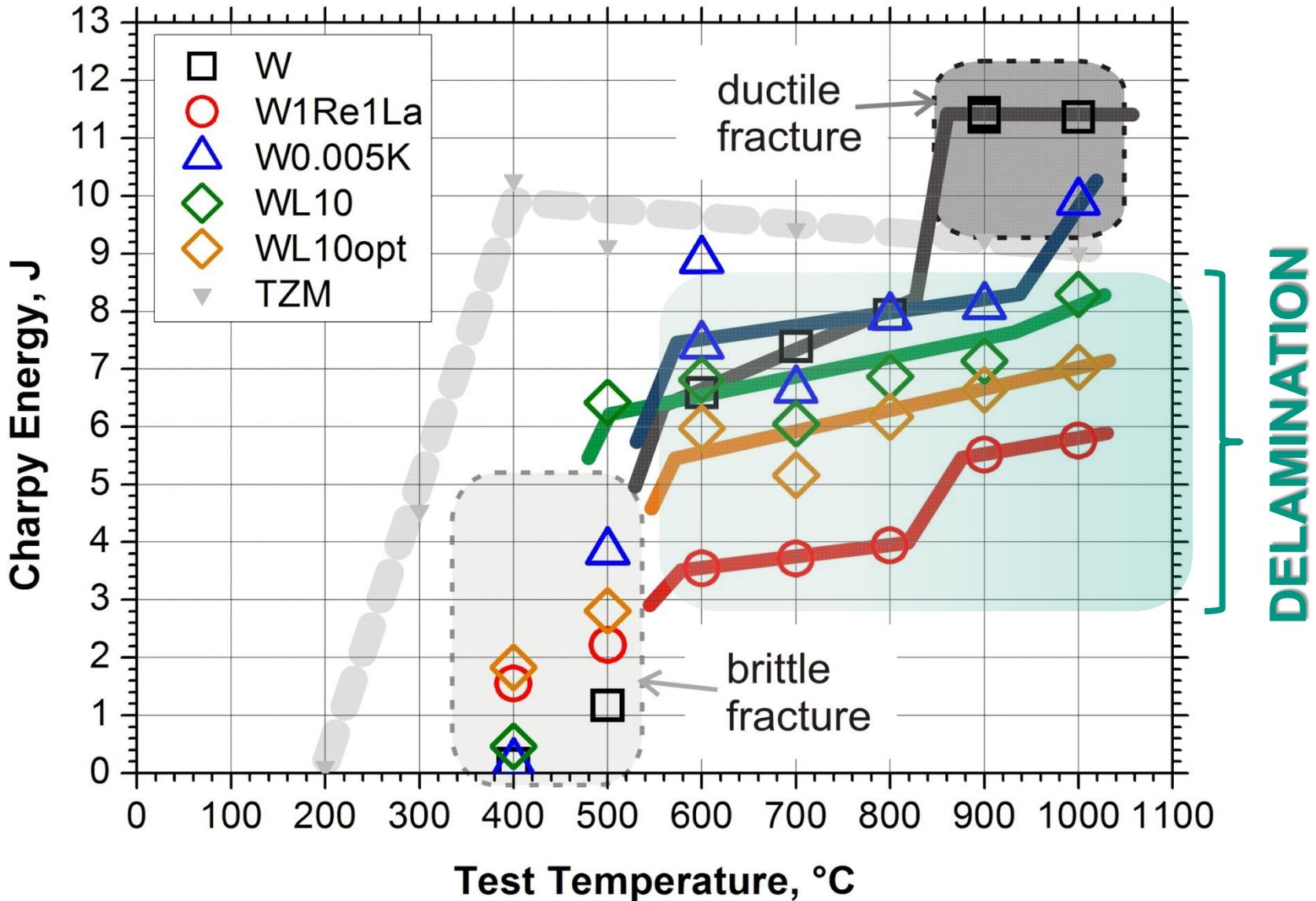
WL10 Rod, Ø7 mm



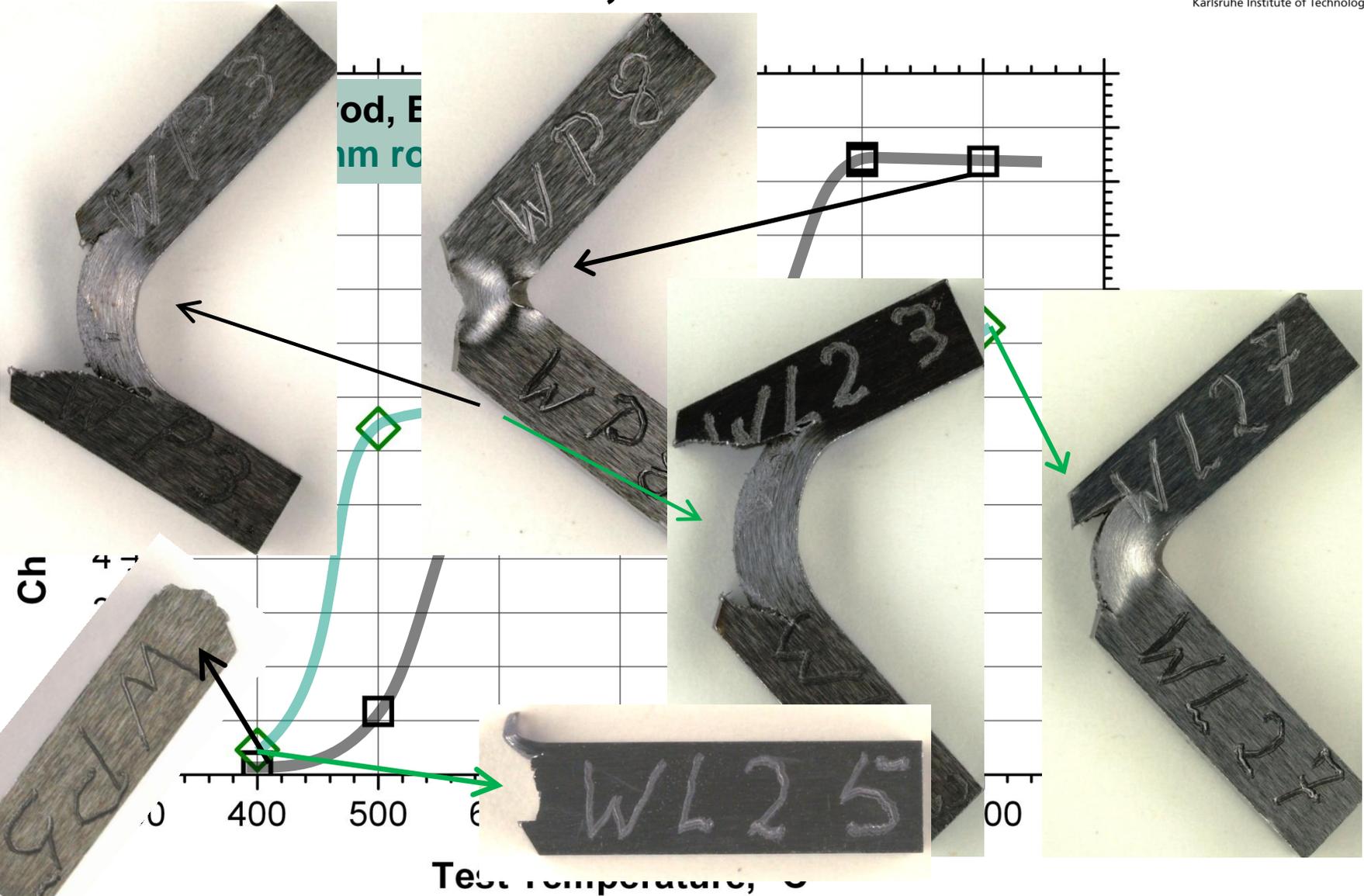
W Rod, Ø7 mm



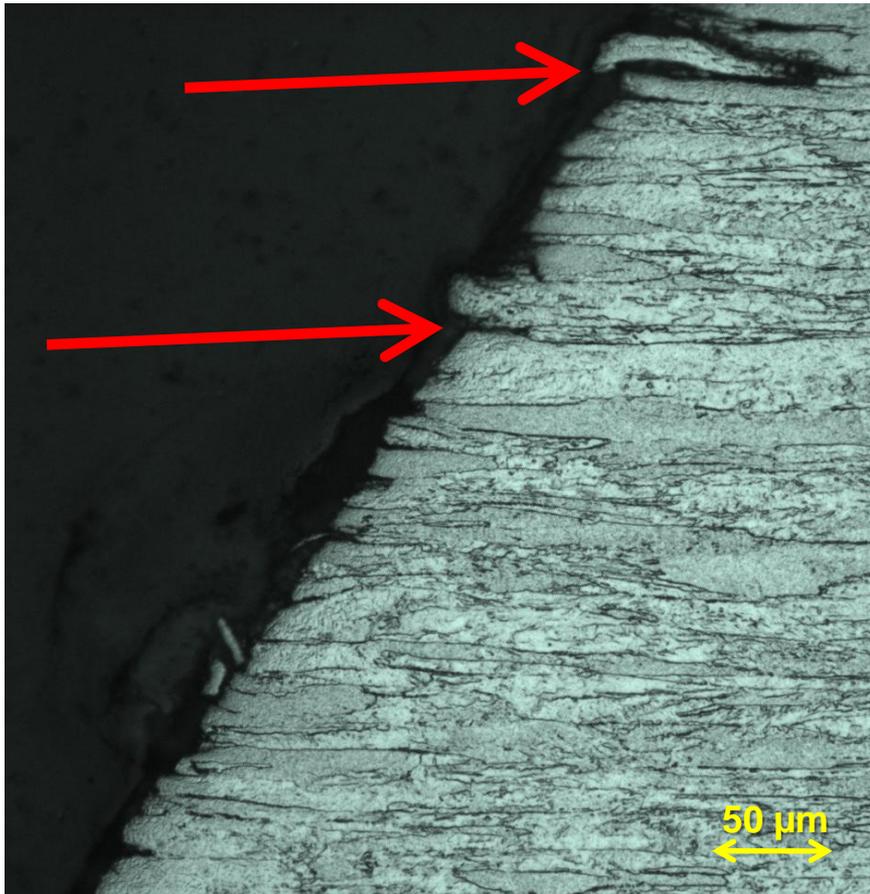
Results, Rod Materials



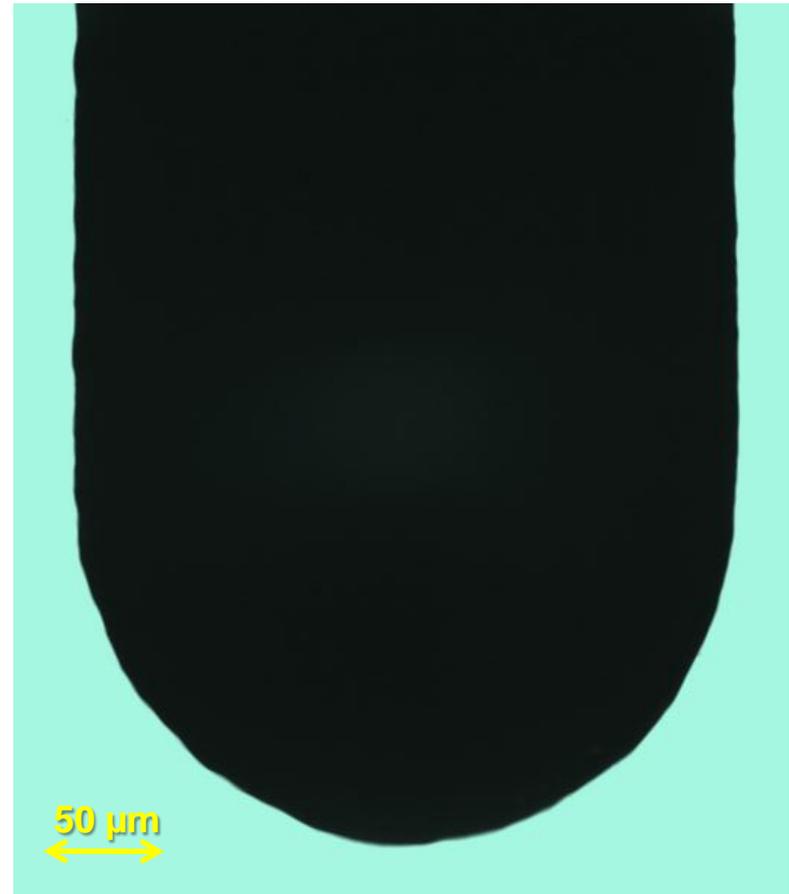
Fracture: W & WL10, 7 mm rods



Surface Fabrication

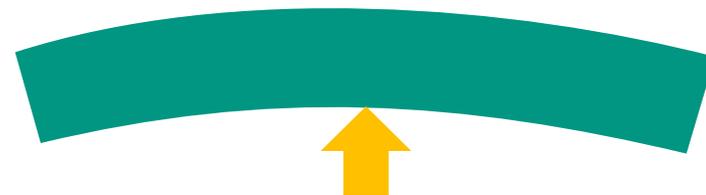
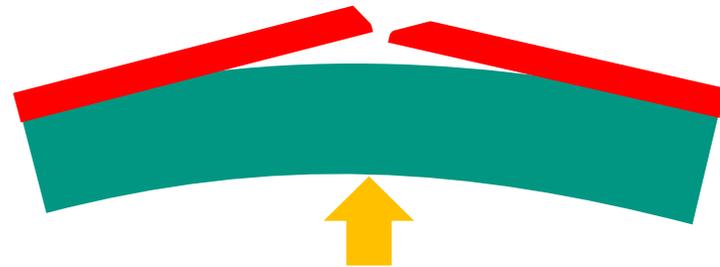
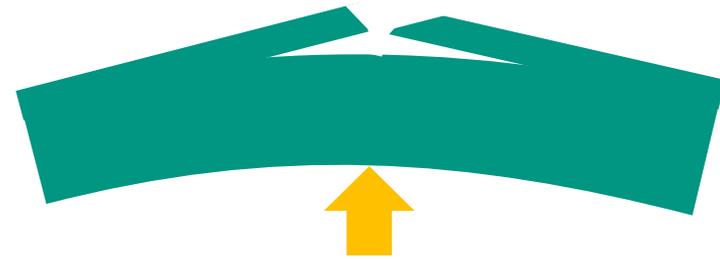


W Rod, EDM

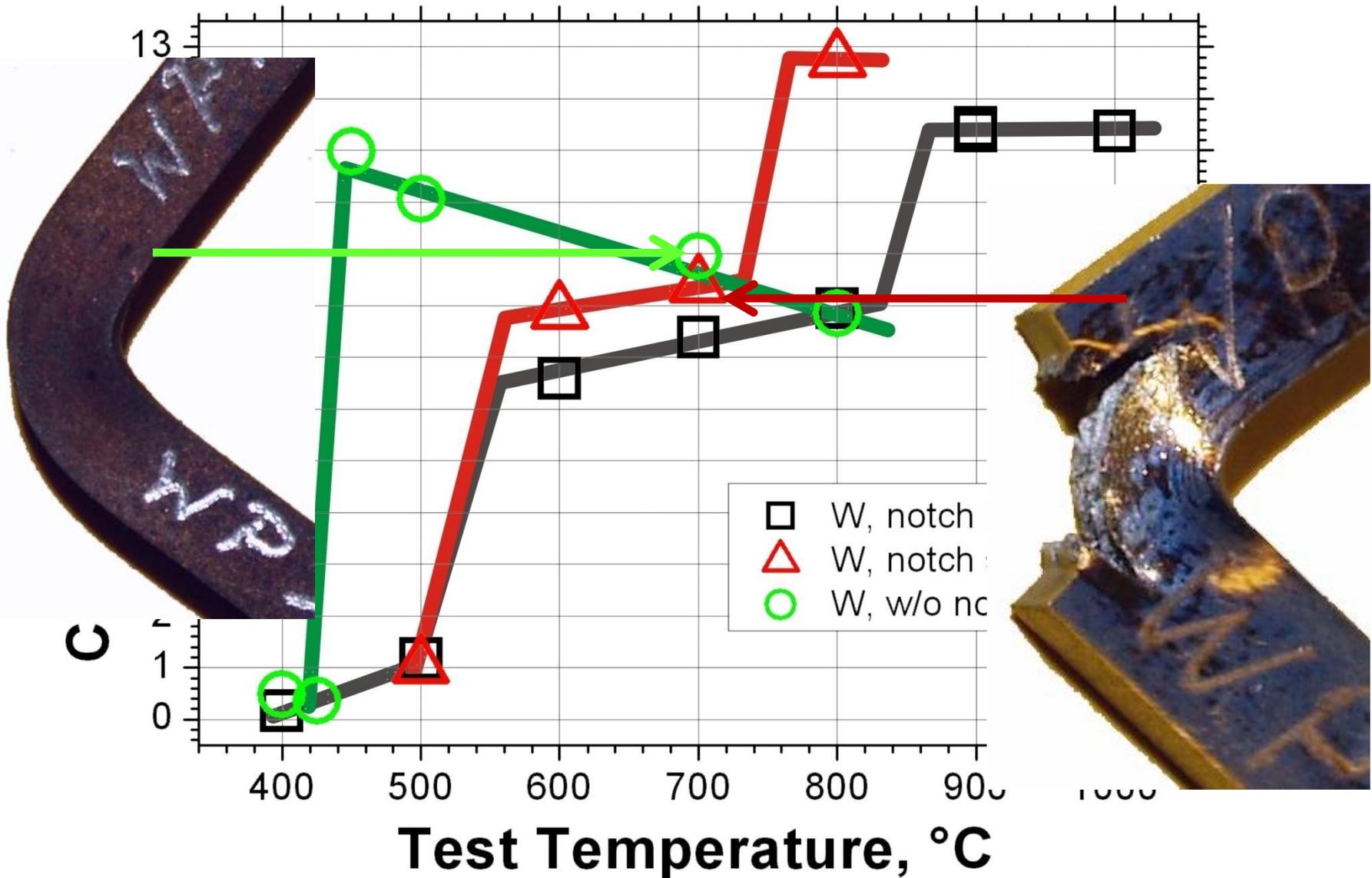


W Rod, Diamond Saw

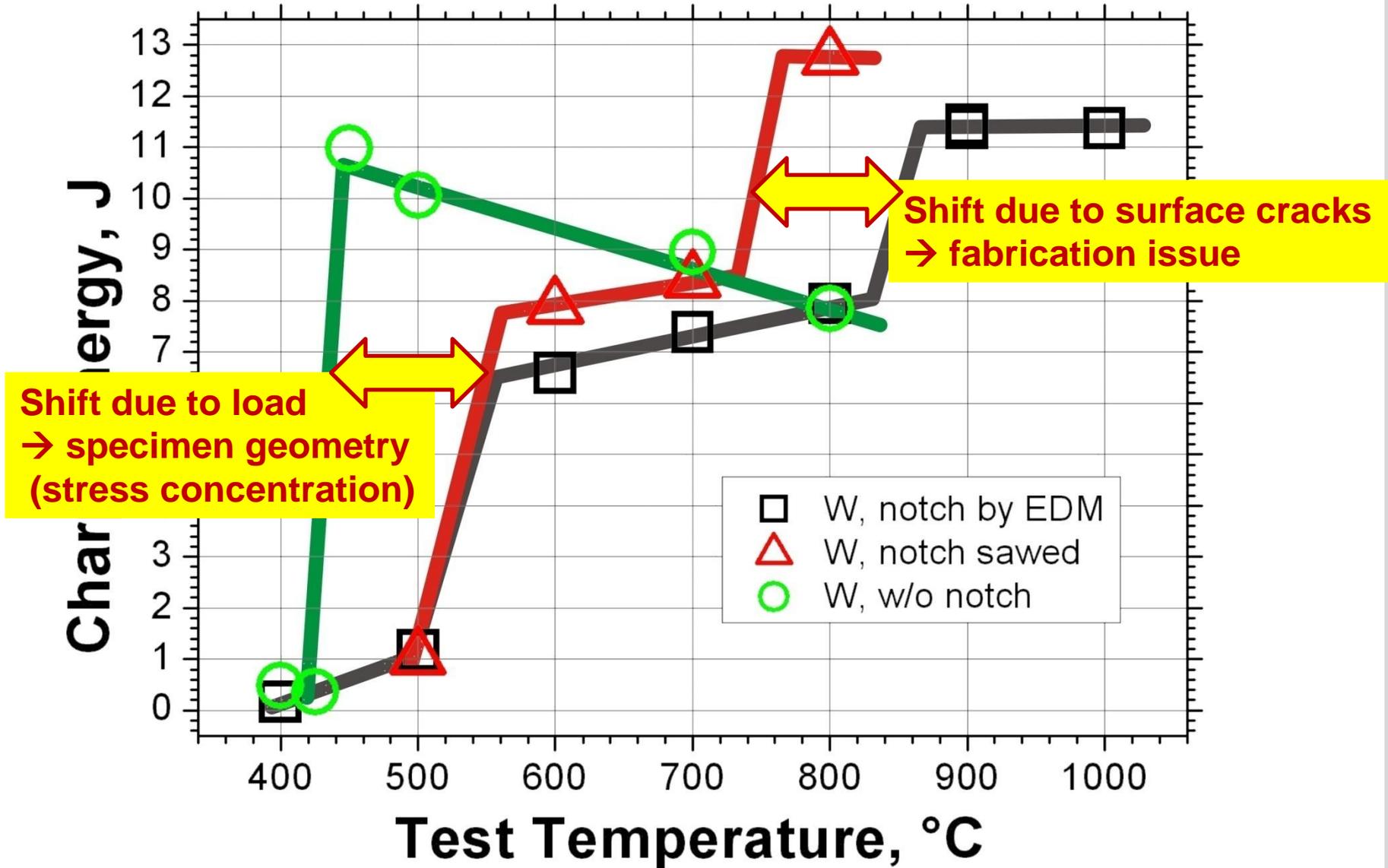
Delamination, Simple Analogy



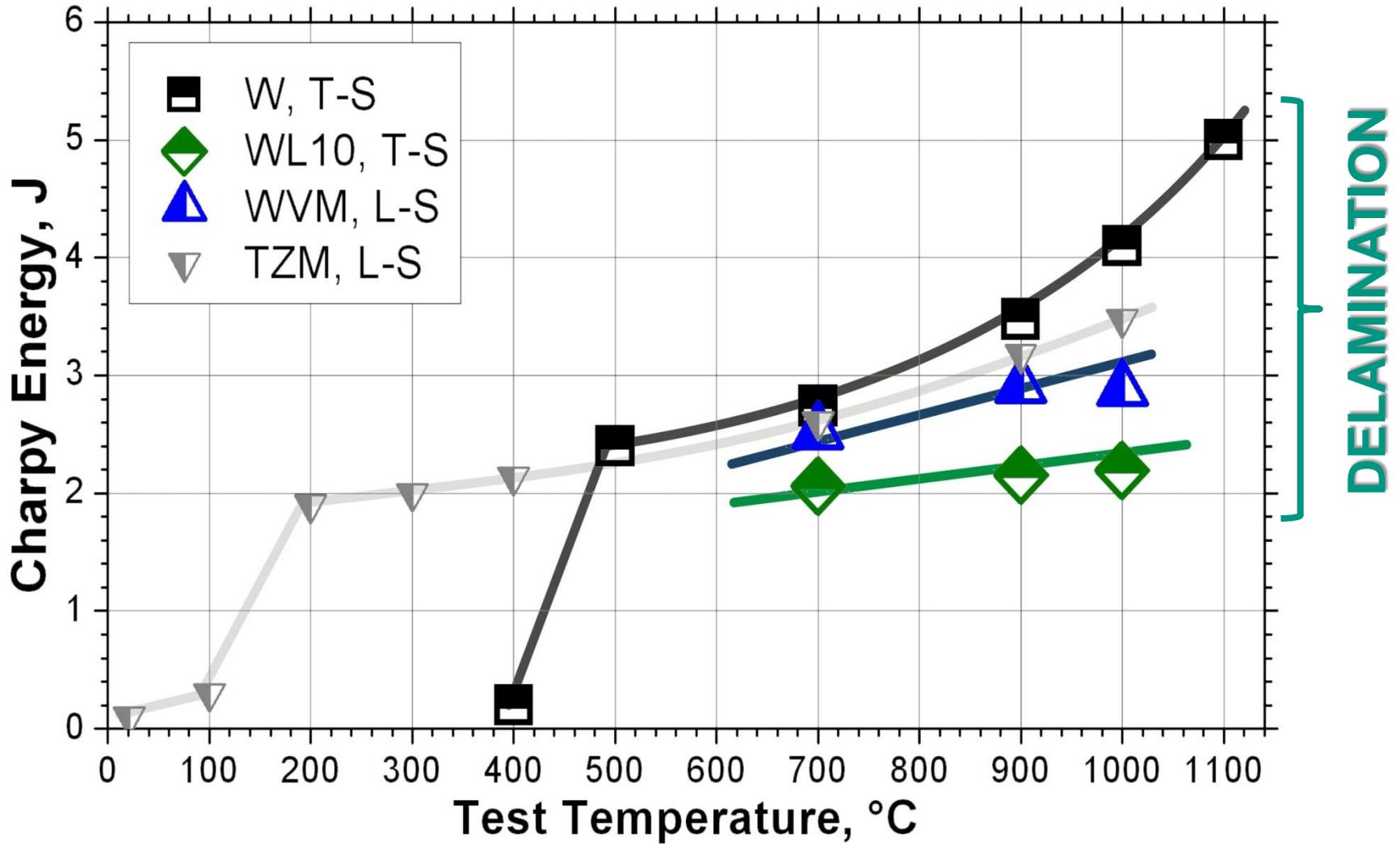
Results, Surface Fabrication



Discussion



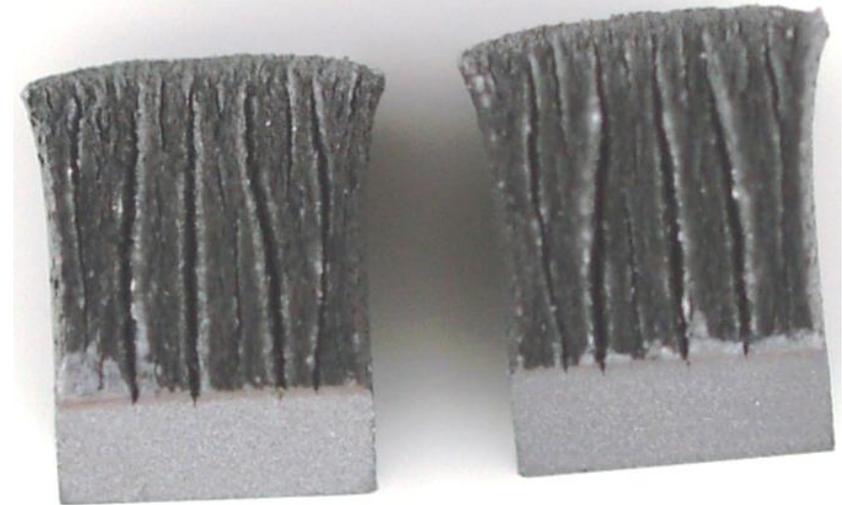
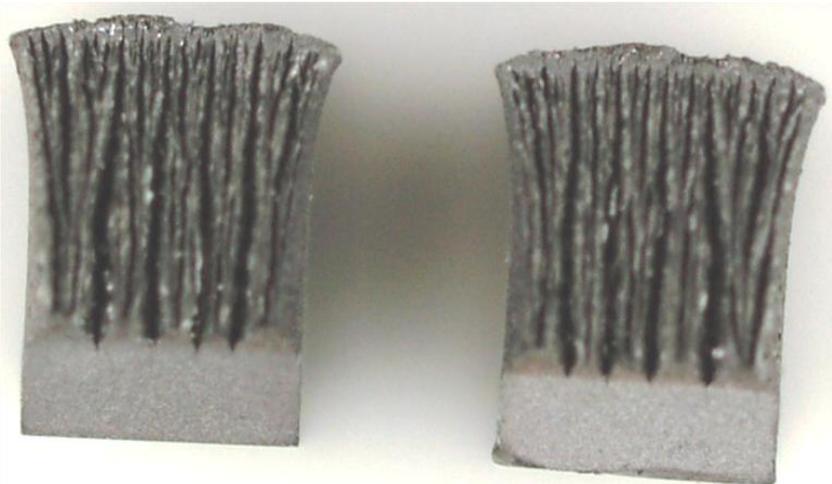
Results, Plate Materials



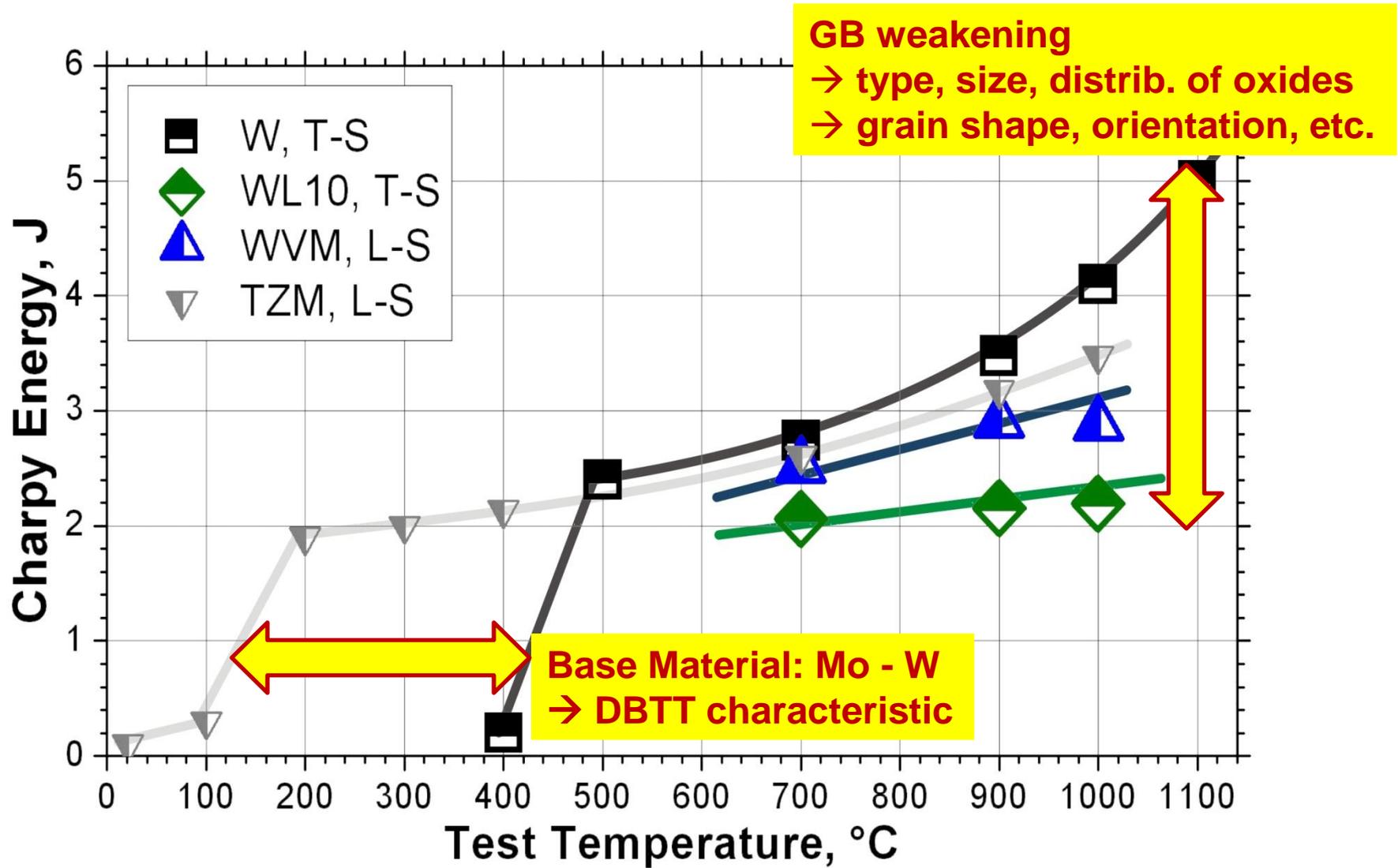
Fracture: W & WL10, plates

W

WL10



Discussion



Conclusions

Rod-Material	DBTT	BDTT / delamin.	DDTT / ductile
TZM	300°C	---	--- / 400°C
W, un-notched	430°C	---	--- / 450°C
W, sawed	---	500°C / ≥600°C	750°C / 800°C
W	---	500°C / ≥600°C	850°C / 900°C
WVM	---	500°C / ≥600°C	950°C / 1000°C
WL10	---	450°C / ≥500°C ?	>1000°C / ???
WL10opt	---	500°C / ≥600°C	>1000°C / ???
W-1Re-1La ₂ O ₃	---	500°C / ≥600°C	>1000°C / ???

Plate-Material

TZM	---	150°C / 200°C	>1000°C / ???
W	---	450°C / 500°C	>1100°C / ???

DBTT: ductile-to-brittle transition temperature

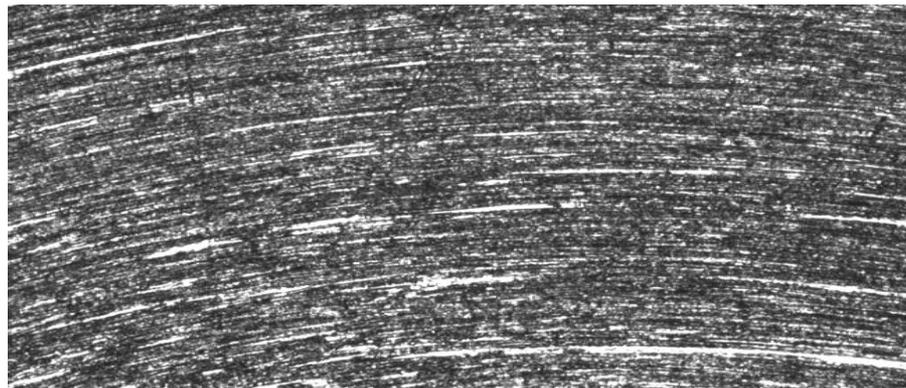
BDTT: brittle-to-delamination transition temperature

DDTT: delamination-to-ductile transition temperature

Conclusions

- ➔ Microstructure significantly defines transition temperatures (rod texture more favorable than that of plates)
- ➔ Oxide particles (and also potassium doping) promote delamination (but they are necessary for stabilizing GB → suppr. re-crystallization)
- ➔ Tungsten materials have a DBTT limit of $\geq 400^{\circ}\text{C}$ (when produced by sintering & deformation, tested according to DIN EN ISO 148-1, ...)
- ➔ Notches/edges have to be avoided in structural parts
- ➔ Optimum fabrication probably only by aligning grains along the contour of the according part → deep drawing, twisting, pressing, ...

Outlook



→ J. Reiser, this conference